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A Resilient 2-D Waveguide Communication Fabric for Hybrid Wired-Wireless NoC Design

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Abstract—Hybrid wired-wireless Network-on-Chip (WiNoCs) has emerged as an alternative solution to the poor scalability and performance issues of conventional wireline NoC design for future System-on-Chip (SoC). Existing feasible wireless solution for WiNoCs in the form of millimeter wave (mm-Wave) relies on free space signal radiation which has high power dissipation with high degradation rate in the signal strength per transmission distance. Moreover, over the lossy wireless medium, combining wireless and wireline channels drastically reduces the total reliability of the communication fabric. Surface wave has been proposed as an alternative wireless technology for low power on-chip communication. With the right design considerations, the reliability and performance benefits of the surface wave channel could be extended. In this paper, we propose a surface wave communication fabric for emerging WiNoCs that is able to match the reliability of traditional wireline NoCs. First, we propose a realistic channel model which demonstrates that existing mm-Wave WiNoCs suffers from not only free-space spreading loss (FSSL) but also molecular absorption attenuation (MAA), especially at high frequency band, which reduces the reliability of the system. Consequently, we employ a carefully designed transducer and commercially available thin metal conductor coated with a low cost dielectric material to generate surface wave signals with improved transmission gain. Our experimental results demonstrate that the proposed communication fabric can achieve a 5dB operational bandwidth of about 60GHz around the center frequency (60GHz). By improving the transmission reliability of wireless layer, the proposed communication fabric can improve maximum sustainable load of NoCs by an average of 20.9% and 133.3% compared to existing WiNoCs and wireline NoCs, respectively.

Index Terms—Hybrid wired-wireless Network-on-Chip, Reliability, Surface Wave, mm-Wave, WiNoC, Waveguide, Wireless Channel.

1 INTRODUCTION

To compensate for the fast-paced technological scalability with the performance bottleneck of conventional metal based interconnects (wireline), the research for alternative interconnect fabrics such as optical networks, three dimensional integrated circuits (3-D ICs) and millimeter wave (mm-wave) has emanated for emerging System-on-Chip (SoC) design [1], [2]. In optical interconnects a photon needs to be converted back to electrons to be stored in the electronic circuitry. Consequently, optical networks have a high design complexity as well as high power, area, and latency overheads. On the other hand, though 3-D ICs are Complementary Metal Oxide Semiconductor (CMOS) compatible and have shorter vertical links with enhanced scalability, 3D integration is still in its infancy due to alignment, low yield and high temperature dissipation issues in the current technology which lowers the reliability of system [3].

RF interconnect has low area and low power consumption due to its CMOS compatibility. However, RF interconnect relies on long transmission lines for guided data transmission which requires alignment between transmission pairs. Mm-Wave, has emerged as a more feasible solution with promising CMOS components that can scale with transistor technology. However, the on-chip antennas and transceivers have non-negligible area and power overheads. Conventional wireline based NoCs on the other hand, are highly efficient for short distances despite their limitations over long distance. Consequently, hybrid wired-wireless Networks-on-Chip (WiNoCs) have emerged to combine the global performance benefits of mm-Wave as well as the short range low power and area benefits of the wireline communication fabric in NoCs. However the wireless communication fabric is lossy and hence lowers the overall reliability of WiNoCs [4]–[6]. Conventional wires have extremely low bit error rate (BER) of around $10^{-14}$ compared to that of mm-Wave (around $10^{-7}$). Moreover, the E-field decay rate of the mm-Wave can be expressed as:

$$E_{\text{decay}} \propto \frac{1}{d}$$

(1)

where $d$ is the separation between the transmitting and the receiving nodes. Consequently, the transmit signal loss on the wireless layer is significantly high. Also, the radiation patterns of the antenna for existing wireless NoCs is limited by a distance of up to 23mm with significantly high power dissipation and losses due to free space propagation [7].

In NoCs, a single message loss can have drastic effects on the performance of the multi-core system. To improve the reliability of existing WiNoCs, error-control-coding (ECC) [1], network coding (NC) [8], retransmission schemes [4], adaptive routing [9], [10] in 3D NoCs with capacitive and inductive coupling links [11] could be employed. However, these techniques rely on the underlying lossy wireless communication fabric for retransmission of handshake signals, erroneous and non-erroneous packets. Therefore, the throughput of WiNoCs is reduced due to the extra timing overhead and retransmitted packets in the network. Hence, novel wireless communication fabrics that offer high data bandwidth as well as improved reliability with BER similar
to the wired communication fabric are required to provide a good trade-off for WiNoCs.

Wireless communication fabric based on the Zenneck surface wave (SW) concept has been proposed as an emerging wireless communication fabric that is power efficient with improved data throughput for long distance communication [12]. The surface wave propagates on a specially designed sheet which is an inhomogeneous plane that supports electromagnetic wave transmission. The signal generated in the 2-D sheet can traverse in all directions providing a natural fan-out feature for supporting realistic on-chip applications such as cache coherency where multicast is dominant. Moreover, a transceiver used in traditional RF or millimeter wave design can be employed for surface wave propagation. However, previous contributions on SW have not focused on optimizing the communication fabric to improve reliability wireless interface [12]. We propose a highly reliable SW communication fabric along with an efficient transducer interface that is able to match the signal integrity of short range wired NoCs. In summary, in this paper:

1) We propose a realistic wireless channel model to evaluate the losses in emerging WiNoCs. Considering both line-of-sight and reflective transmission in traditional WiNoCs an on-chip reflection channel model which accounts for the transmission medium and built-in material of a practical chip is developed. Experimental analysis of the proposed realistic channel model reveals that, the performance degradation due to separation distance between on-chip antennas is higher with low reliability compared to a conventional channel, modeled over free space.

2) We improve the overall reliability of hybrid wired-wireless Networks-on-Chip on a commercial PCB substrate (Taconic RF-43 [13]). The substrate is basically a thin metal layer coated with low cost dielectric material to support the generated surface wave signals as the reliable wireless communication medium. Additionally, we evaluate the performance of a carefully designed transducer for on-chip wireless communications.

3) We present the design considerations for the realization of the proposed SW fabric as an alternative communication fabric for the wireless layer of WiNoCs. Depending on the selected parameters of the surface wave communication fabric, evaluated results show that a wide-band 5 dB operational bandwidth of about 40GHz to 60GHz can be achieved around 60GHz operational frequency.

4) We perform cycle-accurate based evaluations of the proposed communication fabric and comparing with emerging WiNoCs as well as conventional reliable wireline communication fabric. Even without any complex error recovery scheme, arbitration or retransmission protocol, the proposed communication fabric can improve the maximum sustainable load of existing WiNoCs and wireline NoCs by an average of 20.9% and 133.3%, respectively, with much lower average packet latency.

The rest of the paper is organized as follows. In Section 2, we present the state-of-the-art contributions on WiNoCs. Section 3 evaluates the reliability of existing wireless communication fabrics for WiNoCs by proposing a realistic channel model. Section 4 presents an reliable WiNoC architecture and formulates the problem of implementing a reliable wireless communication fabric for WiNoCs. Section 5 presents an improved wireless communication fabric for WiNoCs. Section 6 evaluates the transmission strength of the proposed wireless communication fabric. Experimental results in Section 7 validates the performance efficiency of the proposed communication fabric. Finally, the main findings are concluded in Section 8.

2 RELATED WORK

Advances in current integration technology makes it possible to implement a wireless transceiver on a silicon die [14]. Hence, several work have been presented in literature to exploit the energy and performance efficiency of long ranged wireless links in the form of mm-wave over the traditional wire-based NoCs [15]. To improve the throughput and power efficiency of both localized and global data transmission hybrid wired-wireless NoCs have already proposed.

One of the key problems with WiNoCs identified in [6] is the transmission reliability of the wireless channel. As an effort to address this issue, Ganguly et al. [1] proposed an error-control-coding for WiNoCs. By implementing a joint cross-talk triple error correction and simultaneous quadruple error detection codes in the wire line links and Hamming code-based product codes in the wireless links with Carbon Nanotube (CNT) antennas, it was demonstrated that the reliability of the wireless channel could be improved. Similarly, ECC has been adapted in [15] to improve the reliability of WiNoCs. However, ECC introduces timing, area and packet overheads which affects the overall transmission efficiency of the WiNoC [4]. Alternatively, Lee et al. [4] adopted an overhearing scheme for WiNoCs. Here a zero-signaling-overhearing-and-retransmission is presented to manage the packet loss along the wireless channel. A checksum-based error-detection and retransmission scheme at the last hop. Vijayakumaran et al. [16] presented an improved filter design to enhance the performance as well as reduce the error probability of incurred by synchronization delays in CDMA based WiNoCs. However, these techniques rely on the underlying lossy wireless communication fabric for retransmission of handshake signals, erroneous and non-erroneous packets.

Surface wave interconnect is an emerging wireless communication fabric that has been demonstrated to be power efficient and with high data throughput for on-chip communication [12]. Previous contributions on SW have focused network architecture and performance with considerations of arbitration, packet routing and efficient handling of multicast packets [12]. However, optimizing the communication fabric to improve reliability wireless interface which is a major issue in WiNoCs have not received much attention. We propose a highly reliable SW communication fabric along with an efficient transducer interface that is able to match the signal integrity of short range wired NoCs.
3 On the Reliability of Existing Wireless Communication Fabric for NoCs

In order to understand the reduction in performance of WiNoCs due to the reliability issues of wireless channel, it is important to characterize the traditional free-space transmission channel for on-chip wireless communication. Among the key challenges of the channel modeling for WiNoC presented in [17], it is emphasized that no comprehensive work on on-chip channel modeling has been reported. Therefore, considering the deployment of antennas operating in the GHz band in the practical chip, the first contribution of the paper is to investigate the effects of various propagation environment parameters inside a chip package on the performance of WiNoCs. Consequently, a wireless channel model is proposed (by considering the physical characteristics of the transmission medium) to analyze the transmission loss components in order to evaluate the reliability of the state-of-the-art wireless communication fabrics for NoCs.

Fig. 1 illustrates a typical WiNoC architecture where two cores $C_T$ and $C_R$ the transmitter and receiver cores, respectively, communicate via millimeter wave channel. Here, we consider a metal cube enclosure as the package with a longest rectangular side of $d_C$ and a height of $h \ll d_C$. Let $h_T$ and $h_R$ denote the height of the mm-Wave antennas (zigzag antennas) at $C_T$ and $C_R$, respectively. The material property of the transmission medium between $C_T$ and $C_R$ is assumed to be time-invariant over the transmission of a data frame and changes independently from one frame to another. Let $d$ denote the distance of separation between $C_T$ and $C_R$. Accounting for chip floorplanning and hence in order to avoid the placement of the cores on/near the edges of the package, $d$ should be less than $d_{\text{max}} = d_C \sqrt{2}$. To accurately model the wireless channel interface of existing WiNoCs, the absorption and resonance of the medium compositions within the chip package should be taken into account, especially in the high frequency band of modern multi-core design. Specifically, various molecules and their isotopologues may cause molecular absorption attenuation (MAA) at various frequency bands [18]. Therefore, the signal transmission between $C_T$ and $C_R$ in Fig. 1 suffers from the path loss caused by not only the free-space spreading loss (FSSL) but also the MAA.

For convenience, the main notation and the well-known constants used in this paper are listed in Tables 1 and 2, respectively. We evaluate the wireless communication fabric for existing wireless Network-on-Chip. Unlike the conventional channel models for the macro-world, on-chip communication introduces new constraints and challenges. Hence in order to study the effect of the wireless channel on the performance of on-chip communication, we propose a channel model that considers the physical dynamics of nanocommunication. In the proposed channel model, the
3.1 Free-Space Spreading Loss (FSSL)

It can be observed in Fig. 1 that the data transmission between two cores can be carried out via both direct line-of-sight (LoS) and reflected transmission. Therefore, in this paper, we develop a two-ray within-package reflection mode mm-Wave NoCs where the total received E-field $E_T(d, f)$ [V/m] at $C_T$ consists of the LoS component $E_L(d, f)$ [V/m] and the reflected component $E_R(d, f)$ [V/m]. Summing up these two components, we have

$$|E_T(d, f)| = |E_L(d, f) + E_R(d, f)| = 2E_0d_0 \sin \left(\frac{\theta(d, f)}{2}\right), \tag{2}$$

where $E_0$ [V/m] is the free-space E-field at a reference distance $d_0$ [m] and $\theta(d, f)$ [rad] is the phase difference between the two E-field components. Here, $\theta(d, f)$ can be approximated by [20]

$$\theta(d, f) \approx \frac{4\pi h_T h_R f}{\zeta_L d}, \tag{3}$$

where $h_T$ [m] and $h_R$ [m] denote the height of the antennas at $C_T$ and $C_R$, respectively, and $\zeta_L = 2.9979 \times 10^8$ m/s is the speed of light in the vacuum.

From (2) and (3), the received power $P_R(d, f)$ [W] at $C_R$ can be computed by

$$P_R(d, f) = \frac{|E_T(d, f)|^2 G_T G_R^2}{480\pi^2 f^2} = \frac{E_0^2d_0^2h_T^2h_R^2}{120\pi^2 f^2} G_T^2 G_R^2 \sin^2 \left(\frac{2\pi h_T h_R f}{\zeta_L d}\right), \tag{4}$$

where $G_T$ denotes the antenna gain at $C_T$. Note that the equivalent isotropically radiated power (EIRP) is given by

$$\text{EIRP} = P_T G_T = \frac{E_0^2d_0^2 h_T^2 h_R^2}{120\pi} \frac{G_T^2}{30}, \tag{5}$$

where $P_T$ [W] and $G_T$ denote the transmitted power and gain of the mm-Wave antenna at $C_T$, respectively. From (4) and (5), $P_R$ can be given by

$$P_R(d, f) = \frac{P_T G_T G_R}{\left(\frac{2\pi d f}{\zeta_L}\right)^2} \sin^2 \left(\frac{2\pi h_T h_R f}{\zeta_L d}\right). \tag{6}$$

Therefore, the FSSL between $C_T$ and $C_R$ (i.e. $L_s(f, d)$) is obtained by

$$L_s(f, d) = \left(\frac{2\pi d f}{\zeta_L}\right)^2 \frac{1}{G_T G_R} \csc^2 \left(\frac{2\pi h_T h_R f}{\zeta_L d}\right). \tag{7}$$

3.2 Molecular Absorption Attenuation (MAA)

The transmission of electromagnetic waves at frequency $f$ through a transmission medium of distance $d$ introduces MAA due to various molecules within the material substance. Applying Beer-Lambert’s law to atmospheric measurements, the MAA of the data transmission from $C_T$ to $C_R$ (i.e. $L_a(f, d)$) can be determined by:

$$L_a(f, d) = \frac{1}{\tau(f, d)} = e^{k(f)d}, \tag{8}$$

where $\tau(f, d)$ and $k(f)$ [m$^{-1}$] are the transmittance and absorption coefficient of the medium, respectively. Here, $k(f)$ depends on the composition of the medium (i.e. particular mixture of molecules along the channel) and it is given by:

$$k_{i,g}(f) = \sum_{i,g} k_{i,g}(f), \tag{9}$$

where $k_{i,g}(f)$ [m$^{-1}$] denotes the individual absorption coefficient for the isotopologue $i$ of gas $g$. For simplicity in representation, the isotopologue $i$ of gas $g$ is hereafter denoted by $(i, g)$.

Applying radiative transfer theory [21], $k_{i,g}(f)$ can be determined by

$$k_{i,g}(f) = \frac{p}{C_0 T_S} Q_{i,g} \zeta_{i,g}(f), \tag{10}$$

where $p$ [atm] is the ambient pressure applied on the designed SoC, $T_S$ [K] is the system electronic noise temperature, $p_0 = 1$ atm is the reference pressure, $T_p = 273.15$ K is the temperature at standard pressure, $Q_{i,g}$ [mol/m$^3$] is the molecular volumetric density (i.e. number of molecules per volume unit of $(i, g)$) and $\zeta_{i,g}(f)$ [m$^2$/mol] is the absorption cross section of $(i, g)$. Here, $Q_{i,g}$ is obtained by the ideal Gas Law as

$$Q_{i,g} = \frac{p}{C_0 T_S} \zeta_{i,g} A_i, \tag{11}$$

where $C_0 = 8.2051 \times 10^{-5}$ m$^3$ atm/K/mol is the Gas constant, $\zeta_A = 6.0221 \times 10^{23}$ mol$^{-1}$ is the Avogadro constant and $g_{i,g}$ [%] is the mixing ratio of $(i, g)$.

In (10), $\zeta_{i,g}(f)$ is given by

$$\zeta_{i,g}(f) = S_{i,g} \xi_{i,g}(f), \tag{12}$$

where $S_{i,g}$ [m$^2$Hz/mol] is the line density for the absorption of $(i, g)$ (i.e. the absorption peak amplitude of $(i, g)$) and $\xi_{i,g}(f)$ [Hz$^{-1}$] is the spectral line shape of $(i, g)$ determined by

$$\xi_{i,g}(f) = \frac{f}{f_c} \tanh \left(\frac{f - f_c}{f_c \alpha} \right) \tag{13}$$

where $f_c$ [Hz] is the resonant frequency of $(i, g)$, $\zeta_P = 6.0262 \times 10^{34}$ Js is the Planck constant, $\zeta_B = 1.3806 \times 10^{-23}$ J/K is the Boltzmann constant and $\xi_{i,g}(f)$ [Hz$^{-1}$] is the Van Vleck-Weisskopf asymmetric line shape of $(i, g)$. In (13),

$$f_c = f_{\text{c}0} + g_{i,g} \frac{p}{p_0}. \tag{14}$$

### Table 2: List of constants

<table>
<thead>
<tr>
<th>Constant name</th>
<th>Symbol</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Avogadro constant</td>
<td>$C_A$</td>
<td>$6.0221 \times 10^{23}$ mol$^{-1}$</td>
</tr>
<tr>
<td>Boltzmann constant</td>
<td>$C_B$</td>
<td>$1.3806 \times 10^{-23}$ J/K/mol</td>
</tr>
<tr>
<td>Gas constant</td>
<td>$C_G$</td>
<td>$8.2051 \times 10^{-5}$ m$^3$ atm/K/mol</td>
</tr>
<tr>
<td>Light speed constant</td>
<td>$C_L$</td>
<td>$2.9979 \times 10^8$ m/s</td>
</tr>
<tr>
<td>Planck constant</td>
<td>$C_P$</td>
<td>$6.6262 \times 10^{-34}$ Js</td>
</tr>
</tbody>
</table>
where \( f_{0}^{(i,g)} \) [Hz] is the resonant frequency of \((i,g)\) at reference pressure \( p_{0} = 1\) atm and \( \delta^{(i,g)} \) [Hz] is the linear pressure shift of \((i,g)\). Also, the Van Vleck-Weisskopf asymmetric line shape of \((i,g)\) in (13) is given by

\[
L^{(i,g)}(f) = 100\zeta_{L} L_{\alpha}^{(i,g)} \frac{f_{0}^{(i,g)}}{f} \left[ \frac{1}{(f - f_{0}^{(i,g)})^2 + (\alpha_{L}^{(i,g)})^2} \right] + \frac{1}{(f + f_{0}^{(i,g)})^2 + (\alpha_{L}^{(i,g)})^2},
\]

(15)

where \( \alpha_{L}^{(i,g)} \) [Hz] is the Lorentz half-width of \((i,g)\). Here, \( \alpha_{L}^{(i,g)} \) is computed by

\[
\alpha_{L}^{(i,g)} = \left[ (1 - q^{(i,g)}) \alpha_{0} + q^{(i,g)} \beta^{(i,g)} \right] \frac{p}{p_{0}} \left( \frac{T_{0}}{T_{S}} \right)^{\omega}.
\]

(16)

where \( \alpha_{0} \) [Hz] is the broadbanding coefficient of air, \( \beta^{(i,g)} \) [Hz] is the broadening coefficient of \((i,g)\), \( T_{0} = 296 \) K is the reference temperature and \( \omega \) is the temperature broadening coefficient. Let \( L(f, d) \) denote the total path loss for signal transmission at frequency \( f \) [Hz] over distance \( d \) [m]. From (7), (8) and (9), the total path loss of the proposed channel model is

\[
L(f, d) = L_{s}(f, d) L_{d}(f, d) = \frac{\pi}{\zeta_{L}} \frac{1}{G_{T} G_{R}} \left[ \frac{2\pi h T R f_{0}}{\zeta_{L} d} \right] \prod_{i,g} e^{-\kappa^{(i,g)}(f) d}.
\]

(17)

**Remark 1** (Effectiveness of the proposed channel model). In (17), it can be shown that \( \kappa^{(i,g)} \geq 0 \forall i, g \). This means the proposed channel model always has a higher total path loss than the conventional channel model with no MAA, and thus can represent the practical scenario as a performance benchmark.

**Remark 2** (Environment-aware channel model). The proposed channel model depends on not only the distance between two cores \( C_T \) and \( C_R \) but also the absorption of gas molecules, the temperature and the ambient pressure applied on the chip. In fact, from (10) - (16), the individual absorption coefficient for the isotopologue \( i \) of gas \( g \) (i.e. \( \kappa^{(i,g)}(f) \)) is shown to be dependent but not monotonically varied over the frequency.

### 3.3 Channel capacity of WiNoCs

We analyze the channel capacity of the wireless channel of WiNoCs with respect to the proposed channel model where the following observations could be made:

2. The channel capacity is measured as the maximum achievable rate at which the information can be reliably transmitted over the communication channel between two wireless cores. The BER can be derived accordingly given the signal-to-noise ratio (SNR) at the receive antenna when considering both PSS and MAA in the channel modeling. Although the BER performance is worth a detailed evaluation, it is beyond the scope of this work.

**Lemma 1.** The channel capacity in bits/s of a nanocommunications system between two on-chip antennas is obtained by

\[
C(P_T, d) = \sum_{k=1}^{K} \Delta f \log_2 \left[ 1 + \frac{P_T G_T G_R \sin^2 \left( \frac{2\pi h \rho_g}{\zeta_{L} d} \right)}{\zeta_B \left( \frac{2\pi h \rho_g}{\zeta_{L} d} \right)^2 \Delta f} \right],
\]

(24)

where \( \Delta f \) is the width of sub-band and \( f_s \) is the center frequency of the \( k \)-th sub-band. Substituting (17) and (22) into (24), we obtain (18) and thus proving the above lemma.
Corollary 1. When \( h_T \ll d, h_R \ll d, d \to 0 \) and \( G_T = G_R = 1 \), the channel capacity of a nanocommunication system can be given by

\[
C(P_T, d) \approx K \sum_{k=1}^{\infty} \frac{\Delta f \log_2 \left( 1 + \frac{P_T h_T^2 h_R^2 T_s \Delta f}{T_s + (T_s + T_b) k^2(\delta_k) d} \right)}{T_s + (T_s + T_b) k^2(\delta_k) d}.
\]

Proof. As \( h_T \ll d, h_R \ll d \) and \( d \to 0 \), applying Macauroin series [22, eq. (0.318.2)], it can be approximated that

\[
\prod_{i,g} e^{\kappa_{i,g}(\delta_k) d} \approx 1 + \sum_{i,g} \kappa_{i,g}(\delta_k) d = 1 + \kappa(\delta_k) d.
\]

Substituting (26) and (27) into (18) with the assumption of \( G_T = G_R = 1 \), the corollary is proved.

It can be deduced from the above realistic on-chip free space wireless channel model that, the total path loss of electromagnetic signal transmission between a transmitting and receiving pair has both FSSL and MAA components which drastically reduce the performance and reliability of WiNoCs as will be shown latter in Section 7. Consequently, it is crucial to explore alternative communication fabric that is able transmit wireless signals with minimum loss. Therefore, as a second contribution, this work presents a novel CMoS compatible communication fabric for on-Chip networks which is able to mitigate the reliability issues of the wireless channel as detailed in the remaining sections of the paper.

4 RELIABLE WIRELESS NoCs

4.1 Network Architecture

A promising way to mitigate the communication overhead incurred by the multi-hop channels among remote cores in traditional wireline NoCs is to adopt wireless communication fabric as a supplementary material. Surface wave communication has been recently demonstrated as a feasible on-chip wireless solution with improved long-range communication, low-power and high bandwidth [12]. Here, the wireless communication layer of WiNoCs is replaced with a waveguide medium as the surface wave communication fabric for global communication which generates a NoC architecture as shown in Fig. 2. The 2-D guided wave reasonably high performance to area ratio with an E-field decay rate of:

\[
E_{\text{decay}} \propto \frac{1}{\sqrt{d}}
\]

Compared to traditional mm-Wave-based WiNoCs, the hybrid wired-SW NoC architecture has significantly reduced power consumption due to the propagation of wireless signal in a 2-D guided medium.

To adapt to the wireless channels, the routers at the wireless nodes in WiNoCs are equipped with a wireless transmission interface which serves as a bridge between the wireless and the wireline communication layers. The wireless transmission interface, responsible for transmitting and receiving wireless signals, works closely with the routing logic, virtual channel allocator, arbiter and crossbar switch for efficient wireless signal transmission. Hence, an unreliable wireless communication fabric with numerous erroneous signal transmissions will increase the competition among the wireline and wireless data for these shared resources.

As an effort to increase the reliability of such networks, the wireless transmission interface can be equipped with a retransmission buffer and a suitable error encoding and decoding scheme. However, the overhead of the erroneous packets as well as the retransmission process introduces contention on the wireless as well as the wireline layers, and hence have drastic effects on the performance of the WiNoC. Moreover, buffer spaces contribute significantly to the total power consumption of the NoC [23] and should be used judiciously.

In the following sections we present the design considerations for the proposed reliable wireless communication fabric in the form of surface wave.

4.2 Problem Formulation

Lemma 2. For Transverse Magnetic mode (TM)-surface wave propagation in a 2-D on-chip communication fabric, a dielectric coated conductor with sufficiently high inductive reactance \( X_i \) is required.

Proof. The TM signal independent of the y coordinate that propagates along the x axis and satisfies the Maxwell equations [24] is evaluated. In free space, Layer 0 (\( \varepsilon = \mu = 1 \)), the

\[
E_x = \frac{Z_0 k_0 j_{k_1(|z|)}}{k_0 e^{j k_1(|z|)}} e^{j \beta x}
\]

where \( k_0 \) and \( Z_0 \) are the number of waves and the impedance of free space, respectively. \( \beta \) is the propagation
constant. Inside the dielectric layer, Layer 1, the electric and magnetic field components are given by:

\[ H_y = \frac{\cos(k_2 z)}{\cos(k_1 |A|)} e^{i(\beta x)} \]  
\[ E_x = -\frac{\beta \cos(k_2 z)}{Z_0 k_0 \cos(k_1 |A|)} e^{i(\beta x)} \]  
\[ E_z = \frac{Z_0 k_2 \sin(k_2 z)}{k_0 i \cos(k_1 |A|)} e^{i(\beta x)} \]

where \( k_1 \) and \( k_2 \) are the transverse waves numbers in Layer 0 and Layer 1, respectively, which can be solved through the Helmholtz wave equation [24]:

\[ K_1 = \sqrt{k_1^2 - \beta^2} \]  
\[ K_1 = \sqrt{k_2^2 + \mu - \beta^2} \]  

The surface impedance \( Z_s \) of the interface between Layer 0 and Layer 1 is given by:

\[ Z_s = -\frac{E_x}{H_y} = -Z_0 \frac{k_1}{k_0}. \]  

To enable the field concentration in Layer 0 nearer to the surface of Layer 1 for TM-surface wave propagation, \( Z_s \) must be inductive. Thus the imaginary part of \( k_1 \) should be positive. Therefore to design a 2-D waveguide fabric for on-chip communication, a dielectric coated conductor with sufficiently high inductive reactance \( X_s \) needs to be implemented.

The surface reactance \( X_s \) for TM surface wave transmission is given by:

\[ X_s = 2\pi f \mu_0 \left( \frac{\sigma - 1}{\epsilon} |A| + 0.5 \Delta \right) \]  

Eq. 38 confirms that the realization of TM mode for 2-D wave propagation for communication is related to the operating frequency, \( f \), dielectric constant, \( \epsilon \), thickness of the dielectric material, \( |A| \), and the skin depth of the metal conductor, \( \Delta \). The skin depth is given by:

\[ \Delta = \sqrt{\frac{1}{\pi f \mu_0 \sigma}} \]  

where \( \sigma \) is the conductivity of the metal conductor.

Lemma 2 shows how surface impedance can be evaluated from the fundamental parameters, the E-field and H-field on the reactive surface. Moreover, our recently published work in [25] reveals that \( S_{21} \), which represents the signal strength transferred from the transducer \( T_x \) to the receiver \( R_x \), can be maximized by the appropriate value of surface impedance \( Z_s \). Hence to solve the problem of improving the reliability of the wireless channel of emerging WiNoCs, our objective is to determine the particular design parameters of the TM surface wave communication medium with a positive surface reactance along with a transducer to operate at a frequency \( f \) such that:

\[ \max_{\forall f x \to R_x \in T(S_{21})} \]  

subject to:

\[ \psi = BER_w - BER_T \]  

where \( \psi \leq \min \) (42)

where \( T \) is the set of transducers with transmitters and/or receivers, respectively. \( BER_w \) and \( BER_T \) are the bit error rates of the wireline and wireless channels, respectively. The most reliable design has a \( \psi = 0 \) and hence the minimum (\( \min \) in Eq 42) must be as close to zero as possible.

5 AN IMPROVED WIRELESS COMMUNICATION FABRIC FOR EMERGING WIRELESS NOC ARCHITECTURES

Surface wave wireless communication medium can be implemented with a thin lossy dielectric coated conductor plane surrounded by free space. Our aim is to design a communication medium with minimum transmission loss as possible in order to improve the reliability of WiNoCs. Fig. 4 shows the functional blocks of the proposed surface wave communication fabric for WiNoC. Here, a dielectric coated metal layer is employed as a guided medium for surface wave signal propagation. With the right design consideration, the transducer and wireless medium could be designed to transmit with minimum communication loss and achieve a transmission reliability similar to the wireline communication layer. To generate an efficient TM surface wave signal, the following considerations are made for the design of the 2-D waveguide sheet. We use commercially available Taconic RF – 43 material. Hence, we employ a low loss and cost-effective TacLamplus material which is laser ablatable, non-reinforced microwave substrate that is ideal for very low loss substrate [13] with 0.2mm thickness as the dielectric (Layer 1 in Fig. 4). For the same frequency, it can be deduced from Eq. 38 that \( X_s \) will increase with \( |A| \). Therefore, more wave will stay on the surface and in effect increase the efficiency. However, for TM surface propagation, \( X_s \) cannot be too high, otherwise the wave will propagate into the dielectric instead of at the boundary of the air-dielectric surface. Hence, by introducing the 0.25mm thick Taconic material, we can achieve a surface reactance

3. With the addition of AC-DC converters the proposed surface wave communication fabric can also be used for on-chip wireless power transmission.

4. Through-Silicon-Via (TSV) is only used internally in the SoC, which sits on top of the surface wave communication fabric (the lowest layer). Due to the difference in thickness between the 2-D waveguide and the height of TSV (about 20µm), it is recommended that the SoC block and surface transducer are fabricated separately and integrated by flip-chip bonding.
If the transducer and the surface wave sheet are properly designed, the employed zigzag antennas are separated by a distance B of 40 free space wavelengths at operating frequency of 60GHz (in this paper). The designed transducer consists of a parallel waveguide fed by an optimized probe through an open aperture. The transducer is coupled to a transceiver circuit which is responsible for modulation, signal transmission and receiving capabilities.

For a reliable transmission, a low power consumption transceiver circuit which has a wide bandwidth with high data throughput must be considered. Hence, we adopt the low-power non-coherent off-keying (OOK) modulator for our implementation. Embedded in the transmitter design is an up-conversion mixer and a power amplifier (PA) while the receiver is equipped with a low noise amplifier (LNA), a baseband amplifier and a down-conversion mixer. A single injection-lock voltage-controlled oscillator (VCO) is used for both the transmitter and the receiver to reduce the area overhead and power consumption. More details on the implementation of the transceiver module along with the circuitry can be found in [5].

At the nodes equipped with both wireless transmission and receiving capabilities, a CMOS-based circulator is employed as a communication bridge between the transmitter, receiver and the 2-D waveguide medium, to enable the use of a single wave feeder at the nodes [26]. It should be noted that some nodes in the WiNoCs do not have transmitting capabilities and hence are only equipped with the receiver circuits. The OOK transceiver is able to achieve a BER less than \(10^{-14}\) and at data rate of at least 16Gbps/s for the designed communication range of 20mm which is comparable to that of the traditional wireline network. Hence in this paper we adopt the above transceiver [5].

Hence, the challenge is to demonstrate that the receive signal power at the destination node is similar to the transmit signal power at the source node over the proposed wireless communication fabric, which is demonstrated in the next section.

### 6 Evaluation of Proposed Wireless Communication Fabric

To demonstrate the effectiveness of the proposed wireless communication fabric, we have performed simulations in Ansys High Frequency Structured Simulator [27]. Fig. 5 shows the HFSS simulation setup. The transducers are placed as far as 200mm (equivalent to 40 free space wavelengths at operating frequency of 60GHz) apart to investigate the signal integrity and the possible performance benefits of the proposed 2D waveguide over existing on-chip wireless NoCs. For comparisons, we have also implemented a model of mm-Wave for on-chip communication. Here, a zigzag antennas which is considered to be the most efficient antenna for mm-Wave on-chip communication is employed. The zigzag antennas are separated by a distance of only 20mm. As shown in Fig. 5, when the transducers and the surface wave sheet are properly designed, the electric field distribution is concentrated in Area2 which demonstrates that a high percentage of the transmitted signal is successfully launched into the surface. Across the long distance separation between of 200mm (from Area1 to Area3) the transducer and transceiver, a near constant electric field distribution is achieved. Also the electric field decays exponentially away from the implemented surface, indicating that surface wave is successfully launched and received with a high signal efficiency.

Fig. 6 compares the \(S_{21}\) (dB) of different technologies. It can be seen that, the reactive surface appears to have a flat response over a wide frequency range and having a 3 dB bandwidth of almost 45GHz (from 35GHz to 80GHz with \(\tan \delta = 0.01\)), and a 5dB bandwidth of almost 60GHz (from 30GHz to 87GHz with \(\tan \delta = 0.01\)). On the other hand, Fig. 6 also shows that the \(S_{21}\) of mm-Wave is around -36dB which is significantly lower than that of the proposed communication fabric. Moreover, though wireline can achieve a high signal strength, transmission frequency high transmission frequency of the wires is inhibited by induced coupling, crosstalk and temperature induced noises [1]. Therefore, the proposed communication fabric is able to successfully excite and transmit high frequency-high bandwidth surface wave signals with high reliability \((S_{21}\) of 0 to -2dB). Consequently, when employed as the wireless communication medium for hybrid wired-wireless NoCs, the proposed fabric improves the reliability of the NoC with a BER comparable to that of wireline NoCs. Fig. 7 shows the propagation loss for different transducer designs, assuming zero dielectric loss. It demonstrates that surface wave signal generated with an off-the-shelf transducer (eg. patch antenna) results in a much lower \(S_{21}\) (around -84dB) at the operating frequency (64GHz). It should be noted that special attention is required to design the transducer to match with the surface impedance \(X_s\) in wide frequency band which...
not realistic for Commercial off-the-shelf (COTS), such as common monopoles or patch antennas. Fig. 8 shows that, for a fixed signal to noise ratio (SNR) of a communication fabric with an attenuation constant $\alpha$, the improvement in rate of change in transmission gain $G_{a, dB}$ for a receiver node placed at $d$ from a transmitting node at $d'$ is given by:

$$G_{a, dB} = \frac{-20}{\log_{10} \left( \frac{d'}{d} \right)} \left[ \log_{10} \left( \frac{d'}{d} \right) + \alpha (d' - d) \log_{10} e \right]$$

of the proposed communication fabric (SW) over mm-Wave increases significantly as the separation between transmitting node and receive node increases. This is because as the distance between the communicating pair increases, the E-field of mm-Wave decays at an exponential rate in free space which lowers the signal strength as shown in Fig. 5. In the wireline channels, there is no need for transceiver circuits to convert wireless signals. Hence at low distances, wireline is more efficient than the wireless communication fabric. However, the delay along the wires have drastic effects which causes significant drop in the rate of transmission gain as the distance to destination node increases. Consequently, the proposed communication fabric provides a feasible performance to distance tradeoff with higher transmission gains and lower delays when combined with wires in hybrid WiNoCs.

![Image](https://example.com/image.png)

**Fig. 8. Variation of ratio of rate of change of transmission gain with distance for different on-chip communication medium**

### 7 EXPERIMENTAL RESULTS

Cycle-accurate experiments are performed using an extended version of Noxim simulator, an open source SystemC simulator for NoCs. The power of the router is modeled with ORION2.0 NoC power simulator. We adapt the BER and the $S_{21}$ of the communication fabric as the error model. We investigate a wide range of WiNoC configurations with buffer depth of 6 flits and packet size of 3 flits. Both regular and non-regular mesh topologies are investigated with a setup as summarized in Table 3. 5 nodes in the WiNoC, which are evenly distributed in the NoC, are equipped with transceivers. All other nodes have receivers. We consider both deterministic XY routing and adaptive West-first routing algorithms. In both cases, the underlying routing algorithm is employed in the wireline layer until a wireless node with a transceiver is encountered. Packets are then sent to the destination node via the single-hop wireless channel. In West-first routing technique we employ buffer level selection scheme to avoid creating bottleneck along the wireless channel. In the experiments we compare the effects of the reliability of the proposed surface wave with mm-Wave in WiNoCs and conventional wireline mesh. Note for a given BER, the packet error ratio which dictates the probability of packet retransmission is given by:

$$p_p = 1 - (1 - p_e)^{|P|}$$  \hspace{1cm} (44)

where $|P|$ is the packet length in bits and $p_e$ is the bit error probability which is the expectation value of the BER for the communication fabric. Thus, Eq. 44 is modeled and imported into the NoC simulator to assign the probability of retransmission of different communication fabrics at different packet injection rates. Alternating bit protocol is used for transmitting and receiving data, and credit flit (ACK/NACK). While wormhole flow control is used for the wireline layer, FDMA media access control is adopted to give more than one node the right to transmit over the shared wireless medium at a data rate of 256Gbps in one clock cycle over 128 carrier frequencies.

#### 7.1 Impact of communication fabric on NoCs

We treat the hybrid wired-wireless network as a whole and evaluate the effect of the wireless communication fabric on the average packet latency. It can be observed in Fig. 15 that hybrid wired-surface wave NoC (SW) has less average packet delays and can sustain about 29% more

<table>
<thead>
<tr>
<th>Simulation setup</th>
</tr>
</thead>
<tbody>
<tr>
<td>NoC dimensions</td>
</tr>
<tr>
<td>Virtual channels</td>
</tr>
<tr>
<td>NoC buffer (flit depth)</td>
</tr>
<tr>
<td>Links and NoC buffer width</td>
</tr>
<tr>
<td>Transceiver nodes</td>
</tr>
<tr>
<td>FDMA carrier frequencies per node</td>
</tr>
<tr>
<td>Fixed BER</td>
</tr>
<tr>
<td>Bit error probability</td>
</tr>
<tr>
<td>Processing element</td>
</tr>
<tr>
<td>Cache</td>
</tr>
</tbody>
</table>

5. The number of transceiver nodes is based on the available frequency range for 46nm, which is estimated to be 4 channels (in addition to the frequencies specified for control signals). However, this range is scaling with technology. Hence in this paper, 5 nodes are adopted [12].

6. The proposed wireless communication fabric is compatible with any wireless NoC topology. However for correlation purposes, we have considered 2-D mesh as the baseline NoC topology.

7. An alternative approach is to inject an erroneous packet after millions of cycles as dictated by the BER which requires extremely large simulation cycles. Experiments conducted with significantly long simulation lengths (which are in order of millions) show that our setup yields similar results (with shorter but reasonable simulation lengths) as the packet error ratio is a directly proportional to the BER.
traffic load compared to mm-Wave WiNoC under both deterministic and adaptive routing in random traffic pattern. The performance improvement is even more significant (over 100%) when SW is compared to conventional wireline network. To validate these findings, we have applied two transpose synthetic traffic patterns where source nodes generate packets to specific destination nodes. As shown in Fig. 10, SW outperforms mm-Wave WiNoC in all cases. Though no special wireless channel selection method is employed in deterministic XY routing (Figs. 9(a), 9(c) and 10(a)), the extra traffic load introduced by the high rate of retransmitted erroneous packets causes contention in both the wireline and wireless channels of mm-Wave WiNoCs. On the other hand, though buffer levels are employed for wireless channel selection in west-first adaptive routing (Figs. 9(b), 10(b), and 10(c)) the error rate along the wireless channel in mm-Wave is much higher than surface wave channel, hence packets in mm-Wave WiNoC experience longer delays compared to SW. We investigate the behavior of WiNoCs under a wide range of regular NoC dimensions with 5 transceiver nodes under random traffic pattern. As shown in Fig. 11(a), SW can sustain about 98% more traffic compared mm-Wave WiNoC when the NoC dimensions is increased to $6 \times 6$. This is mainly due to the stronger signal strength with minimum BER of the SW channel over mm-Wave when the distance between remote nodes is increased. Consequently, the number of erroneous packets and retransmissions injected into the network in mm-Wave WiNoC due to the lossy wireless channel increases the network contention even under medium traffic conditions. However, the maximum sustainable load of SW drops to about 25% more efficient compared to mm-Wave WiNoC when the dimension is increased to $10 \times 10$. This is expected as the number of nodes equipped with transceivers is kept constant (5 transceiver nodes) in all cases. As evident in the significantly low saturation rate of traditional wireline NoC (Fig. 11) the contention in the wireline layer have more dominant effect on average packet latency as the number of nodes in the network increases over fixed number of wireless nodes. On the average, SW improves the maximum sustainable load by 27.8% and 133.3% compared to mm-Wave and wireline, respectively, even when a small number of wireless transmitting nodes are used.

### 7.2 Realistic Applications

To further validate the performance benefits of the proposed communication fabric, M5 simulator [28] is employed to acquire memory access traces from a full system running PARSEC v2.1 benchmarks [29] which is used to drive our cycle-accurate network simulator. In the setup, 64 two-wide superscalar out-of-order cores with private 32KB L1 instruction and data caches as well as a shared 16MB L2 cache are employed. Following the methodology presented in Netrace [30], the memory traces are post-processed to encode the dependencies between transactions. Consequently, the communication dependencies are enforced during the simulation. Memory accesses are interleaved at 4KB page granularity among 4 on-chip memory controllers. A summary of the benchmarks is presented in Table 4. Thus we apply a wide range of benchmarks with varied of granularity and parallelism to study the effects of different wireless communication fabrics on WiNoCs. For each trace, we simulate at least 100 million cycles of the PARSEC-defined region of interest (ROI) where we schedule 2 threads per core. Fig. 12 shows the average performance improvement of SW over mm-Wave WiNoC and wireline in terms of average packet latency in realistic traffic traces. In all workloads, SW communication fabric can has lower packet latency compared with other on-chip communication fabrics. Particularly, in high contention workload such as swaptions and channeal with large number of packets simulated over a wide simulation cycle the proposed communication fabric achieves over 60% improvement in the average packet latency compared to the baseline (wireline) NoC. Fig. 13 shows that the electric field decay rate (estimated with Eq. 1 and 28) of SW signal is much slower than that of mm-Wave. Particularly, the reduced rate of decay of SW signal compared to mm-Wave signal is consistent with the improvement in power consumption presented in Fig. 14.

#### 7.3 Power consumption

Both static and dynamic power of the router is calculated in Orion2.0 model for 45nm technology. The wireline links along the $x$ and $y$ dimensions are modeled as 3.6mm and 5.2mm, respectively. For the wireless link power analysis along the surface wave and mm-Wave channels, we exploit the $S_{21}$ signal voltage gain between the transmitter and receivers [12]:

$$S_{21} = E + 20 \log e^{-\alpha d} \quad (45)$$

where $\alpha$ is the attenuation constant of the wireless communication fabric, $d$ is the separation between the transmitting and receiving nodes and $E$ is the loss constant due to the transducer. Based on extracted values from a Matlab fitting tool [12] and conducted experiments (see Section 6), $\alpha$ is calculated as 6.33 and $E$ values of $-23.8$ and $-1$ are calculated for mm-Wave and surface wave, respectively. For the power consumption of the transceiver $24mW$ per sub-channel is used [31]. These values have been imported in to the simulator for power estimation. In general, for high contention workload such as swaptions and channeal with large number of packets simulated an average leakage power and dynamic power of 15$mW$ and 35$mW$, respectively, was recorded for mm-Wave, while an average of 8.3$mW$ leakage power and 35$mW$ leakage power was recorded for WiNoCs with surface wave. Fig. 14 shows the power efficiency of surface wave over mm-Wave in various WiNoC dimensions and under different traffic patterns. For PARSEC benchmark we use medium input set for all traces except swaptions where large input set is adopted. The figure shows that mm-Wave consumes up to 17% more power compared to the MHz WiNoC.
proposed surface wave fabric when employed as the wireless communication channel for WiNoCs under synthetic traffic patterns. The percentage increase in power savings is even more significant under realistic traffic traces. This is because the mm-Wave channel is lossy with high signal loss constant due to free space propagation while the proposed surface wave communication fabric transmits TM signals with high $S_{21}$. Particularly, due to reduction in the number of erroneous packets and retransmissions, the SW reduces the dynamic power consumption by an average of 20% compared to mm-Wave. Therefore, the proposed surface wave communication fabric has more promising power efficiency for long distance communications in WiNoCs compared to traditional mm-Wave.

### 7.4 Effect Wireless Channel on the Reliability of WiNoCs

To understand the effect of the wireless channel on the total reliability of WiNoCs, the performance evaluation of the mm-wave wireless channel is carried out by investigating the realistic channel model proposed in Section 3. We
Fig. 14. Average network power efficiency.

compare with conventional channel model where signals are transmitted over pure air with no MAA (e.g. two-ray channel model in [20])

The simulation is implemented in MATLAB and the parameters of various gas compositions are obtained from the HITRAN database [18]. The impacts of the transmission medium and various channel environment parameters on the performance of mm-Wave WiNoC in terms of path loss and channel capacity are evaluated with respect to different channel modeling approaches.

First, we investigate the impacts of antenna transmission frequency on the wireless channel model. Fig. 15(a) plots the variation of the total path loss (i.e. L) of the two considered channel models with transmission frequency at $C_T$. Two cores $C_T$ and $C_R$ (i.e. $d_C$) are implemented on a chip with a die size of 20mm$^2$ and the height (i.e. $h$) of 1mm. The distance between $C_T$ and $C_R$ (i.e. $d$) is set to be 0.1mm, satisfying $d < d_C/\sqrt{2}$. Each core deploys a zigzag antennas having an elevated height of 0.02mm (i.e. $h_T = h_R = 0.02$mm). The transmission frequency of the antennas (i.e. $f$) is assumed to vary in the range from 55GHz to 65GHz. The system electronic noise temperature (i.e. $T_S$) is 296 K and the ambient pressure applied on the chip (i.e. $p$) is 1atm.

It can be observed in Fig. 15(a) that the realistic channel model for WiNoCs results in a higher total path loss compared to the conventional channel model. Also, the total path loss is shown to not monotonically increase at the GHz frequency band due to the fact that the MAA is caused by isotopologues of gases having various absorption coefficients at various frequencies. For example, the MAA causes a very high path loss at about 61.6GHz. These observations confirm the statements in Remarks 1 and 2 regarding the effectiveness of the proposed channel model with environment-aware property.

The impacts of operating temperature of the chip on the channel of WiNoC are shown in Fig. 15(b), where the total path loss of the proposed and the conventional channel models is plotted against the system electronic noise temperature (i.e. $T_S$) with respect to two different values of frequency band (i.e. $f = 60$GHz and $f = 64$GHz). It can be observed that the system temperature does not have any effects in the conventional channel model with only FSSL, while the total path loss in the proposed channel model is shown to decrease as the temperature increases at both frequency bands. This observation accordingly verifies the statement in Remark 2 on the monotonically decreasing total path loss over the system temperature due to the MAA.

Taking the ambient pressure of WiNoCs into consideration, Fig. 15(c) plots the total path loss of various channel models versus the ambient pressure (i.e. $p$ in kPa) applied on the chip package. It can be seen in Fig. 15(c) that the total path loss in the conventional channel model is independent of the ambient pressure. However, the total path loss in the proposed channel model for practical WiNoC is shown to exponentially increase as the ambient pressure increases, which confirms the claim of the exponentially increased total path loss over the ambient pressure in Remark 2. It is noted that, although there is a small difference in terms of total path loss when varying temperature, frequency and/or ambient pressure, such small changes result in a considerable difference in the achievable capacity. For instance, as shown in Fig. 15(d), it can be observed that the capacity decreases more than 10 Mbits/s as the temperature slightly changes from 300K to 302K. A similar effect can be observed when either the frequency and/or ambient pressure changes. Considering the impact of distance between two cores on the performance of WiNoC, in Fig. 15(e), the total path loss of various channel models is plotted. We consider the transmission distance between $C_T$ and $C_R$ (i.e. $d$) with respect to two values of frequency $f = 60$GHz and $f = 64$GHz. The distance $d$ is assumed to vary in the range $[10 : 100]$μs and the other simulation parameters are similarly set as in Fig. 15(a). It can be observed that the total path loss in both the proposed and the conventional channel models increases as the distance increases, which could be straightforwardly verified from the path loss expression in (17). However, there is only a slightly increase of the path loss in the conventional model at the GHz frequency band, while such increase is shown to be significant with a much higher path loss in the proposed channel model, which is in fact caused by the consideration of the MAA to reflect the practical WiNoC.

We investigate the impacts of MAA in the proposed channel model on the achievable channel capacity of WiNoCs. Fig. 15(f) plots the channel capacity against the distance between two cores $C_T$ and $C_R$. Similarly, two channel models including the proposed and the conventional models are considered for comparison and the parameters are set as in Fig. 15(e). The antennas are assumed to operate at frequency $f = 60$GHz. As shown in Fig. 15(f), the channel capacity in the proposed channel model for the practical WiNoCs is lower than that in the conventional channel model, even when the distance between two cores is less than 0.01mm. This observation can be intuitively verified through the impacts of the transmission distance on the total path loss.

8. In our model, the medium compositions consist of water vapour (which could also an effect of emerging liquid cooling technology), carbon dioxide, oxygen, nitrogen, ozone, molecular hydrogen, nitrous oxide, methane, dioxygen, nitrogen oxide, sulfur dioxide, acetylene, ethane, ethylene, methanol, hydrogen cyanide, ethane, ethylene, methanol, hydrogen cyanide, chloroform, hydroxyl radical, hydrogen chloride, chlorine monoxide, carbon monoxide, formaldehyde, hypochlorous acid, hydrogen peroxide, phosphine, carbonyl fluoride, sulfur hexafluoride, hydrogen sulfide, formic acid, hydroperoxyl radical, chlorine nitrate, nitrosium ion, hypobromous acid, bromomethane, acetonitrile, carbon tetrafluoride, diazirine, cyanacrylate, carbon monosulfide, sulfur trioxide.

9. Note that 1atm = 101.325kPa.
8 Conclusion and Future Work

In this paper, a reliable 2-D waveguide communication fabric is proposed to alleviate the performance degradation due to high error rates of the wireless communication channel in hybrid wired-wireless NoCs. The TM characteristics for reliable surface wave signal propagation in the proposed communication fabric is evaluated. As a result, a thin metal layer coated with Taconic RF-43 dielectric material is designed as the 2-D wireless communication medium. A low noise quarter-wave transducer is then proposed as the interface between the SoC blocks and the wireless interface. Experiments conducted in HFSS show that the proposed transducer has a significantly high bandwidth (45GHz - 60GHz). Finally, the performance effect of introducing the proposed wireless communication fabric in hybrid wired-wireless NoCs is evaluated by cycle-accurate simulations. The experimental results show significant reductions in the average packet delay and power consumption compared to millimeter wave hybrid wired-wireless NoCs with both adaptive and deterministic routing techniques. Future work includes a realistic channel model for the proposed 2-D wireless communication medium, optimized WiNoC for multicast and cache coherence protocols in chip multiprocessors (CMPs), as well as a low area coding scheme to reduce network congestion due to erroneous transmission along existing lossy wireless channels for NoCs.

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